





NPN SURFACE MOUNT TRANSISTOR

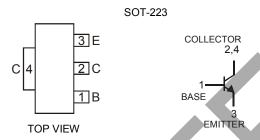
Features

- Epitaxial Planar Die Construction
- Complementary PNP Type Available (DCP52)
- Ideally Suited for Automated Assembly Processes
- Ideal for Medium Power Switching or Amplification Applications
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)

Mechanical Data

- Case: SOT-223
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Matte Tin annealed over Copper leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Marking & Type Code Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.115 grams (approximate)





Schematic and Pin Configuration

Maximum Ratings @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	60	V
Collector-Emitter Voltage	V _{CEO}	60	V
Emitter-Base Voltage	V _{EBO}	5	V
Peak Pulse Current	I _{CM}	1,5	A
Continuous Collector Current	I _C	1	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation @ T _A = 25°C	D.	1 (Note 3)	W
1 ower Dissipation & TA = 23 C	' a	2 (Note 4)	VV
Operating and Storage Temperature Range	T _j ,T _{STG}	-55 to +150	°C
Thermal Resistance Junction to Ambient Air @ T _A = 25°C (Note 3)	$R_{ heta JA}$	125	°C/W

Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Conditions
OFF CHARACTERISTICS (Note 5)						
Collector-Base Breakdown Voltage	V _{(BR)CBO}	60			V	$I_C = 100 \mu A, I_E = 0A$
Collector-Emitter Breakdown Voltage	V _{(BR)CEQ}	60		_	V	I _C = 10mA, I _B = 0A
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	5			V	$I_E = 10\mu A, I_C = 0A$
Collector Cut-Off Current				100	nA	$V_{CB} = 30V, I_{E} = 0A$
	ICBO		_	20	μΑ	$V_{CB} = 30V, I_E = 0A, T_A = 150^{\circ}C$
Emitter Cut-Off Current	I _{EBO}			10	μΑ	$V_{EB} = 5V, I_{C} = 0A$
ON CHARACTERISTICS (Note 5)						
Collector-Emitter Saturation Voltage	VCE(SAT)			0.5	V	I _C = 500mA, I _B = 50mA
Base-Emitter Turn-On Voltage	V _{BE(ON)}			1.0	V	I _C = 500mA, V _{CE} = 2V
		40		250		I _C = 150mA, V _{CE} = 2V
DC Current Gain	h_{FE}	25			_	I _C = 500mA, V _{CE} = 2V
DCP55-16		100		250		I _C = 150mA, V _{CE} = 2V
SMALL SIGNAL CHARACTERISTICS						
Transition Frequency	f_T		200		MHz	I _C = 50mA, V _{CE} = 5V, f = 100MHz

Note:

- 1. No purposefully added lead.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- 3. Device mounted on FR-4 PCB pad layout as shown on page 4 or on Diodes, Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 4. Device mounted on Polyimide PCB with a copper area of 1.8cm².
- 5. Measured under pulsed conditions. Pulse width = 300μs. Duty cycle ≤2%

DCP55/-16

Document number: DS30707 Rev. 8 - 4

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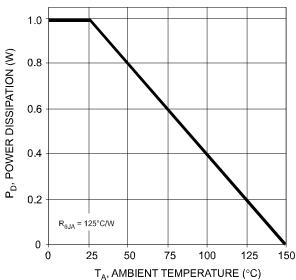
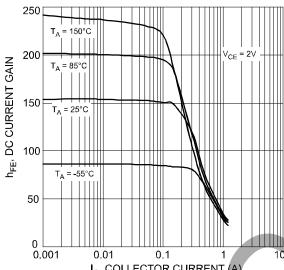
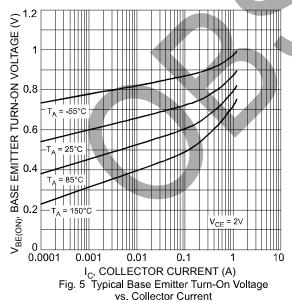
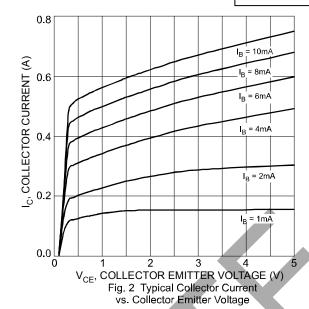


Fig. 1 Power Dissipation vs. Ambient Temperature



I_C, COLLECTOR CURRENT (A)
Fig. 3 Typical DC Current Gain vs. Collector Current





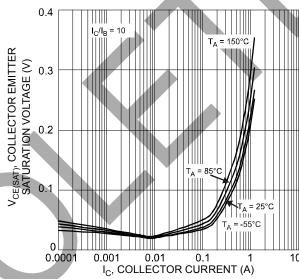


Fig. 4 Typical Collector Emitter Saturation Voltage vs. Collector Current

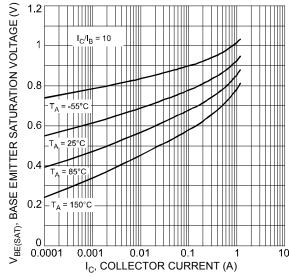
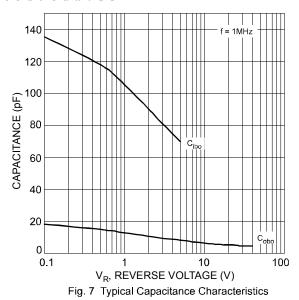
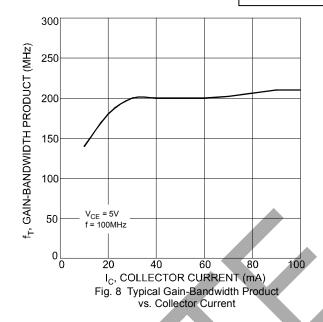


Fig. 6 Typical Base Emitter Saturation Voltage vs. Collector Current





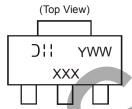


Ordering Information (Note 6)

Device	Packaging	Shipping
DCP55-13	SOT-223	2500 / Tape & Reel
DCP55-16-13	SOT-223	2500 / Tape & Reel

6. For packaging details, please visit our website at http://www.diodes.com/datasheets/ap02007.pdf. Note:

Marking Information

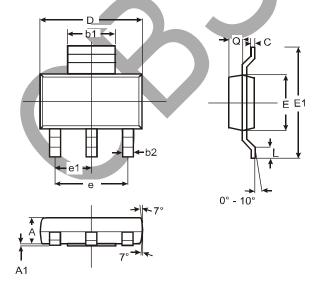


DII = Manufacturer's code marking XXX = Product type marking code Ex: N16 = DCP55

N16-16 = DCP55-16

YWW = Date code marking Y = Last digit of year ex: 7 = 2007 WW = Week code 01 - 52

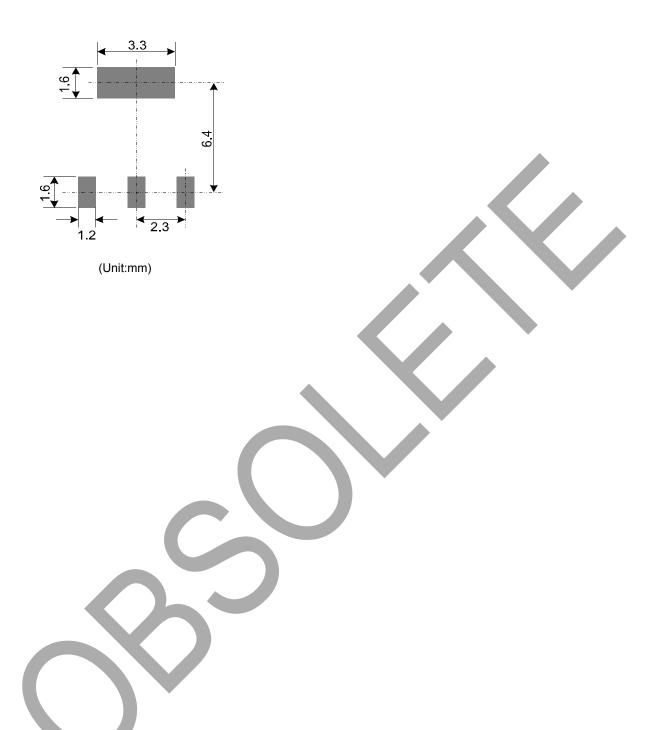
Package Outline Dimensions



SOT-223					
Dim	Min	Max	Тур		
Α	1.55	1.65	1.60		
A 1	0.010	0.15	0.05		
b1	2.90	3.10	3.00		
b2	0.60	0.80	0.70		
С	0.20	0.30	0.25		
D	6.45	6.55	6.50		
Е	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
е	_	_	4.60		
e1	_	_	2.30		
L	0.85	1.05	0.95		
Q	0.84	0.94	0.89		
All Dimensions in mm					



Suggested Pad Layout: (Based on IPC-SM-782)





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